APPLICA	BLE STAN	IDARD										
OPERATING			STOP			RAGE IPERATURE RANGE		iF	-10°C TO + 60°C(-10°C TO + 60°C (NOTE3)		
RATING	TEMPERATURE RANGE OPERATING HUMIDITY RANGE		20 % TO 80 % (NO		STORAGE			_	·			
		INGE	AC/DC 100V		APPLI	DITY RA		+	40 % TO 70 % (NOTE3)			
	VOLTAGE		AWG 28 : 1.0		CONNECTOR			+	DF50-*DS-1C DF50-2830SCFA			
CURRENT			AWG 30 : 0.9		CON	TACT			DI 30 2000001	Л		
			AWG 32 : 0.7 A									
			SPEC	CIFICA	OITA	NS						
	EM		TEST METHOD				F	REQU	IREMENTS	QT	АТ	
	RUCTION	Tyrou i Ai i i y	AND DV ME AGUIDING INGTO	INACNIT	1.	A C C C I	DINO T	0.00	AVA/INIO		T	
GENERAL EXAMINATION MARKING		VISUALLY AND BY MEASURING INSTRUMENT. CONFIRMED VISUALLY.				ACCORDING TO DRAWING.				X	X	
	IC CHARA											
			/ MAX 1mA (DC OR 1000 F	Hz).	3	0mΩ N	IAX.					
INSULATION	N	, , ,				00MO	MIN			X		
RESISTANC	E					500MΩ MIN.				X		
VOLTAGE P	ROOF	300V AC FOR 1 min.			N	NO FLASHOVER OR BREAKDOWN.				Х	-	
	NICAL CH											
MECHANIC		30TIMES INSERTIONS AND EXTRACTIONS.				① CONTACT RESISTANCE: 50mΩ MAX.						
OPERATION							DAMAGI PARTS.	⊑, CR	RACK OR LOOSENESS	X	-	
VIBRATION					1	1 NO ELECTRICAL DISCONTINUITY OF 1µs. 2 NO DAMAGE, CRACK OR LOOSENESS				X		
		0.75 mm, AT 10 CYCLE FOR EACH, FOR 3 DIRECTIONS.					DAMAGI PARTS.	E, CR	ACK OR LOOSENESS	^	-	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.										
EN\/IB⊜I	NMENITAL		ACTERISTICS									
DAMP HEAT			DAT 40 ± 2 °C, 90 TO 95 °C	%, 96 h.	(① COI	NTACT R	RESIS	TANCE: 50mΩ MAX.			
(STEADY STATE)						② INSULATION RESISTANCE: 100MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS				-		
		TEMPERATURE -55→+85°C				OF PARTS.						
RAPID CHANGE OF TEMPERATURE		TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK				 CONTACT RESISTANCE: 50mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_	
		IS 2~3 m										
COUNT	T 5	ECODIDITIO	ON OF BEVILLONG	.	DESIGN	JED.	I		CHECKED		\	
COUN	T DESCRIPTION OF REVISIONS DE		nE91G1	SIGNED			CHECKED		ATE			
·\				I			APPRO\	VED	KI. AKIYAMA	10.0	06. 03	
						CHECKED		ŒD	OM. MIYAMOTO	10.0	06. 03	
							DESIGNED TT. OHSAKO		TT. OHSAKO	10.0	06. 01	
					DRAWN		/N	TT. OHSAKO	10.0	06. 01		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DR	PRAWING NO. ELC4-3322			ELC4-332213	-01				
HS.	S	PECIFI	CATION SHEET	TON SHEET PA		ART NO.		DF50-*DP-1H(51)				
						DDE NO.			CL665- o		1/2	
ENDM HD0011_2_1			CODE			_ NO. ULUUU-			0L000	J	112	

SPECIFICATIONS							
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ			
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	x	_			
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 220°C WITHIN 60 sec «PREHEATING AREA» 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_			

REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD.

AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specifid, refer to JIS C 5402.

Note QT:0	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC4-332213-01		
HRS	SPECIFICATION SHEET	PART NO. DF50-*DP-1H			51)	
	HIROSE ELECTRIC CO., LTD.	CODE NO		CL665-	A	2/2